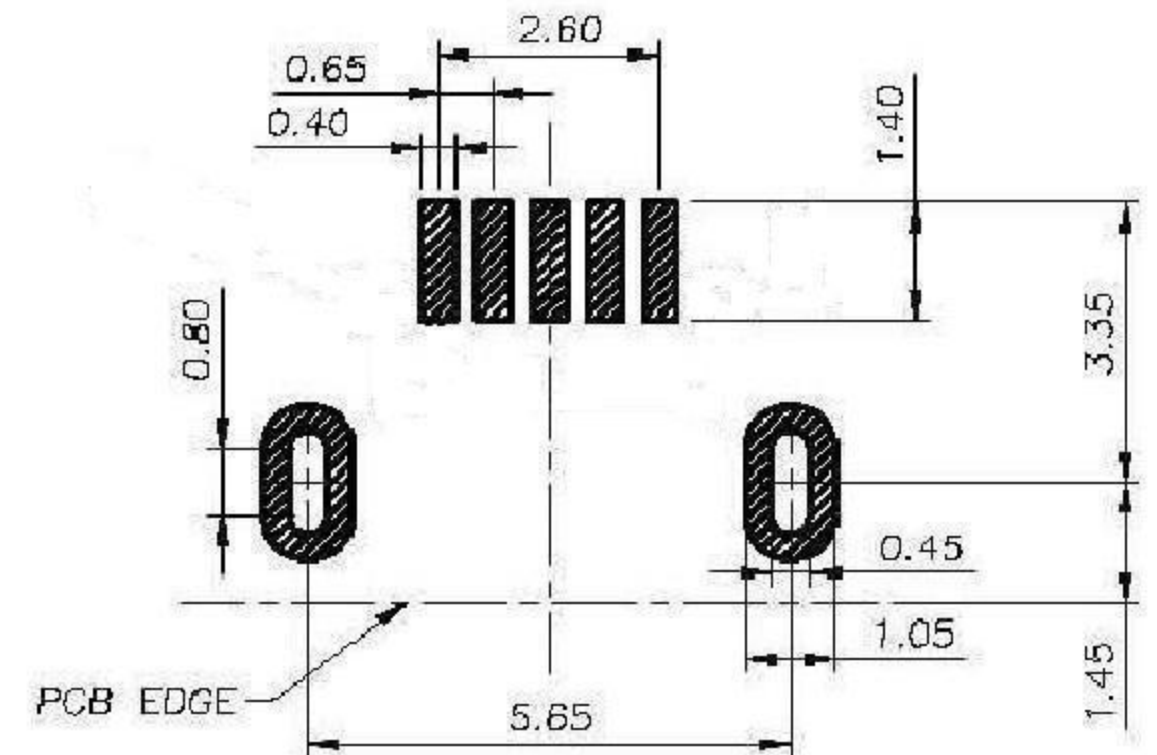
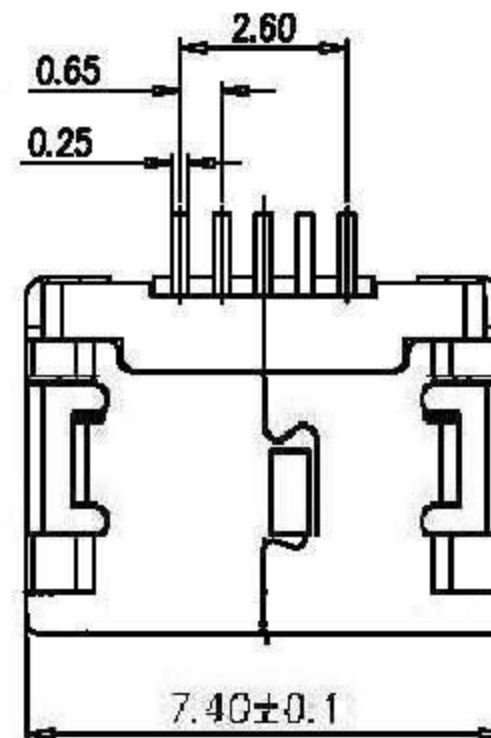
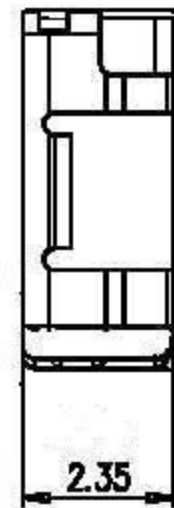
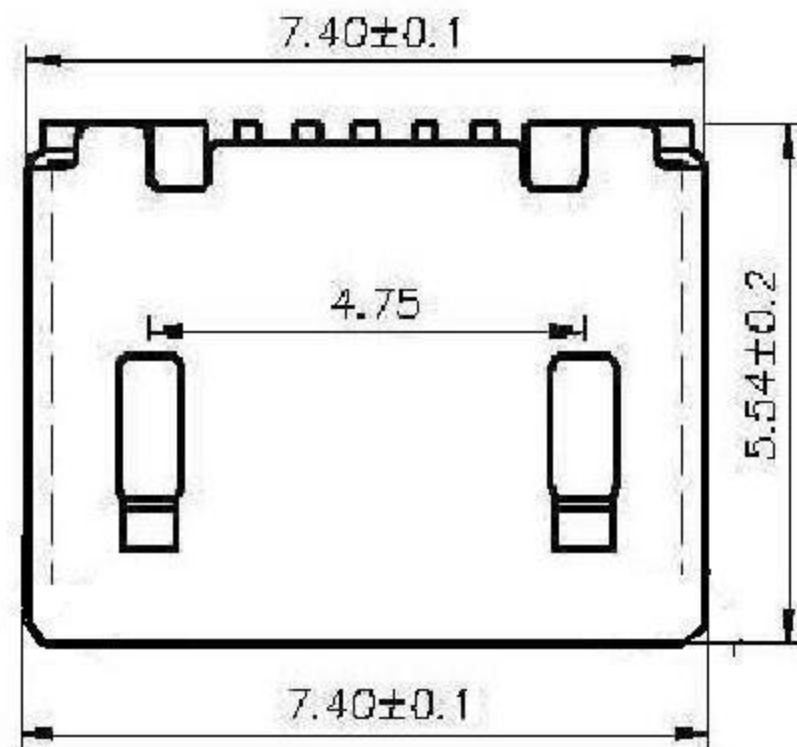
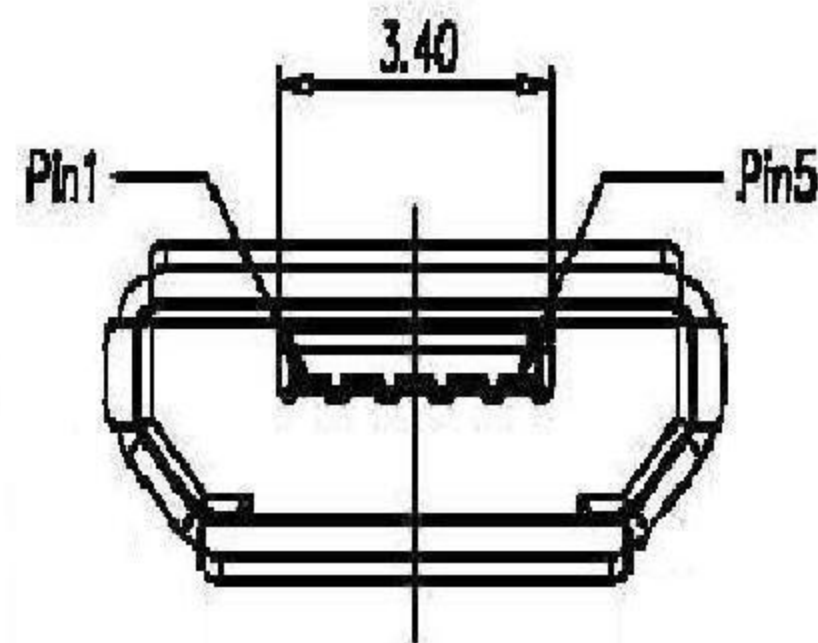




RECOMMENDED PCB LAYOUT (TOL:±0.05)



NOTES:

- 1)MATERIAL:
HOUSING: THERMOPLASTIC,UL 94V-0,30%G/F FILLED;
COLOR: BLACK
CONTACT: COPPER ALLOY T=0.15mm
SHELL: SUS 304, T=0.25mm
- 2)FINISH:
CONTACT: 3u" GOLD PLATING ON CONTACT AREA
G/F PLATING ON SOLDER TAILS
50~80u" MIN.NICKEL UNDERPLATING OVER ALL
SHELL: 50~80u" NICKEL UNDER ,80~120u" MATTE TIN OVERALL

TOLERANCE		UNIT	MM	深圳市连欣科技有限公司	
GENERAL		MATERIAL	SEE NOTE	TITLE	MICRO USB 5P 5.65插脚SMT平口
X.	±0.30	FINISH BY		DWG NO.	XUDF-0432-0121
.X	±0.20	APPR.BY		SIZE A4	
.XX	±0.10	CHK.BY	贾爱华		
.XXX	±0.05	DWG.BY	赵晓慧		
ANGLES					
X.	±2.0°				
.X	±1.0°				
.XX	±0.5°				

REV.	ECN NO.	MODIFICATION	DWG.	CHK.	APPR.
A					